

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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SURFACE MOUNT PRECISION ZENER DIODE

Features

- · Small, Surface Mount Package
- Ideally suited for Automated Assembly Processes
- Very Sharp Breakdown Characteristics
- Very Tight Tolerance on Zener Breakdown Voltage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOD323
- Case Material: UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed over Alloy 42
 Leadframe. Solderable per MIL-STD-202, Method 208 [®]
- Weight: 0.004 grams (Approximate)



Top View

Ordering Information (Note 4)

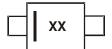
Device	Packaging	Shipping
(Type Number)-7*	SOD323	3,000/Tape & Reel
(Type Number)-13* (Note 5)	SOD323	10,000/Tape & Reel

^{*} For (Type Number), please see the Electrical Characteristics Table. Example: 6.2V Zener = UDZ6V2B-7.

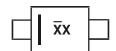
Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html
- 5. Devices are readily available on 13" reels for select voltages only. For other voltages, devices can be made available on 13" reels upon request. Please Contact your Diodes Inc. sales representative for additional details.

Marking Information



XX = Product Type Marking Code for SAT (Shanghai Assembly/Test Site) (See Electrical Characteristics Table)



XX = Product Type Marking Code for CAT (Chengdu Assembly/Test Site) (See Electrical Characteristics Table)



Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ heta JA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

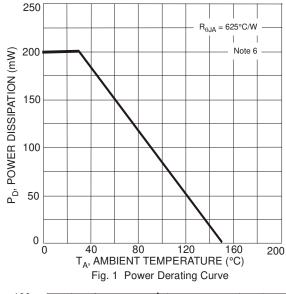
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

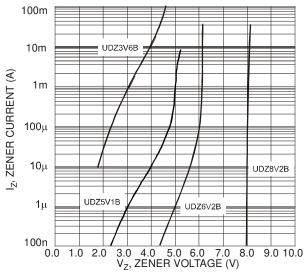
Type Marking		Zener Voltage Range (Note 7)		Maximum Zener Impedance (Note 8)			Maximum Reverse Current (Note 7)		
Number		V _{ZT @} I _{ZT}		I _{ZT}	Z _{ZT} @ I _{ZT}	Z _{ZK} @ I _{ZK}	I _{ZK}	IR	V _R
		Min (V)	Max (V)	mA	2	Ω	mA	uA	V
UDZ3V6B (Note 9)	B7	3.600	3.845	5	100	1,000	1.0	10	1.0
UDZ3V9B (Note 9)	B8	3.890	4.160	5	100	1,000	1.0	5	1.0
UDZ4V3B (Note 9)	В9	4.170	4.430	5	100	1,000	1.0	5	1.0
UDZ4V7B (Note 9)	ВА	4.550	4.750	5	100	800	0.5	2	1.0
UDZ5V1B (Note 9)	BB	4.980	5.200	5	80	500	0.5	2	1.5
UDZ5V6B	BC	5.490	5.730	5	60	200	0.5	1	2.5
UDZ6V2B	BD	6.060	6.330	5	60	100	0.5	1	3.0
UDZ6V8B	BE	6.650	6.930	5	40	60	0.5	0.5	3.5
UDZ7V5B (Note 9)	BF	7.280	7.600	5	30	60	0.5	0.5	4.0
UDZ8V2B	BG	8.020	8.360	5	30	60	0.5	0.5	5.0
UDZ9V1B	BH	8.850	9.230	5	30	60	0.5	0.5	6.0
UDZ10B	BI	9.770	10.210	5	30	60	0.5	0.1	7.0
UDZ11B	BJ	10.760	11.220	5	30	60	0.5	0.1	8.0
UDZ12B	BK	11.740	12.240	5	30	80	0.5	0.1	9.0
UDZ13B	BL	12.910	13.490	5	37	80	0.5	0.1	10.0
UDZ15B	BM	14.340	14.980	5	42	80	0.5	0.1	11.0

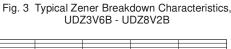
Notes:

- Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
 Short duration pulse test used to minimize self-heating effect.
 The Zener impedances (Z_{ZT}, Z_{ZK}) are measured by superimposing a minute alternating current on the regulated current (I_Z).
 AEC-Q101 qualified.









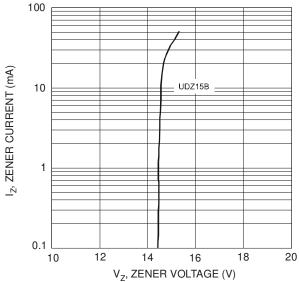
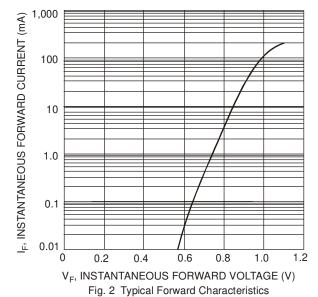


Fig. 5 Typical Zener Breakdown Characteristics, UDZ15B



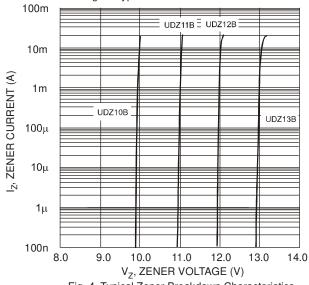


Fig. 4 Typical Zener Breakdown Characteristics, UDZ10B - UDZ13B 30 25 C_T, TOTAL CAPACITANCE (pF) 20 15 0V Bias 1V Bias 10 2V Bias 5 0 10 12 16 V_Z , NOMINAL ZENER VOLTAGE (V) Fig. 6 Typical Total Capacitance

vs. Nominal Zener Voltage



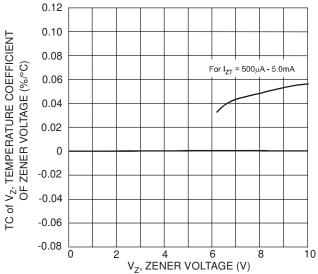


Fig. 7 Typical Temperature Coefficient of Zener Voltage vs. Zener Voltage, UDZ6V2B-UDZ10B

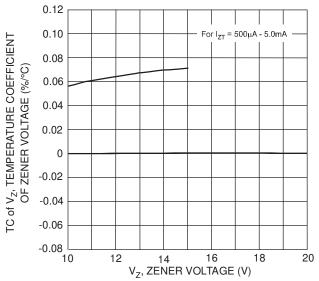


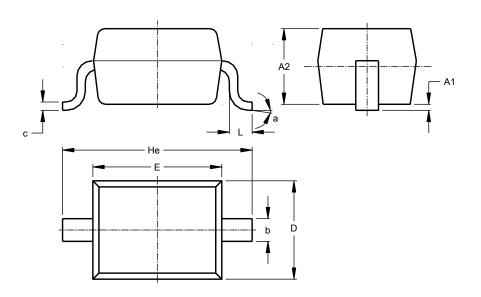
Fig. 8 Typical Temperature Coefficient of Zener Voltage vs. Zener Voltage, UDZ10B-UDZ15B



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD323

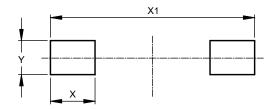


SOD323					
Dim	Min	Max	Тур		
A 1		0.10	0.05		
A2	1.00	1.10	1.05		
b	0.25	0.35	0.30		
С	0.10	0.15	0.11		
D	1.20	1.40	1.30		
Е	1.60	1.80	1.70		
He	2.30	2.70	2.50		
L	0.20	0.40	0.30		
а	0º	8º			
All Dimensions in mm					

Suggested Pad Layout

 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

SOD323



Dimensions	Value (in mm)
Х	0.590
X1	2.700
Υ	0.450



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